

REVISIONS																			
LTR	DESCRIPTION	DATE (YR-MO-DA)	APPROVED																
A	Changes in accordance with N.O.R. 5962-R220-94.	94-07-08	M. A. FRYE																
B	Make changes to dimensions c, L, L1, and note 1 specified under figure 1. Redrawn. - ro	98-07-22	R. MONNIN																

REV																			
SHEET																			
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REV STATUS	REV	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B
OF SHEETS	SHEET	1	2	3	4	5	6	7	8	9	10	11	12	13					
PMIC N/A		PREPARED BY RICK C. OFFICER					DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216												
STANDARD MICROCIRCUIT DRAWING THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS AND AGENCIES OF THE DEPARTMENT OF DEFENSE AMSC N/A		CHECKED BY CHARLES E. BESORE																	
		APPROVED BY MICHAEL A. FRYE					MICROCIRCUIT, LINEAR, LOW DISTORTION, PRECISION, WIDE BANDWIDTH OPERATIONAL AMPLIFIER, MONOLITHIC SILICON												
		DRAWING APPROVAL DATE 93-06-09																	
				REVISION LEVEL B					SIZE A	CAGE CODE 67268	5962-90868								
							SHEET 1 OF 13												

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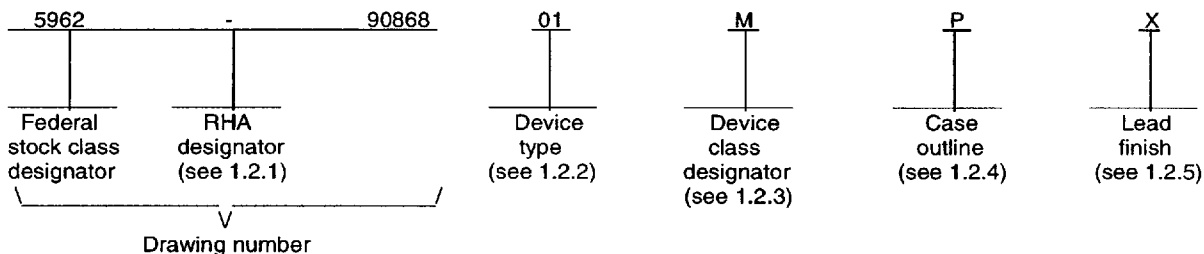
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1. SCOPE

1.1 Scope. This drawing documents two product assurance class levels consisting of high reliability (device classes Q and M) and space application (device class V). A choice of case outlines and lead finishes are available and are reflected in the Part or Identifying Number (PIN). When available, a choice of Radiation Hardness Assurance (RHA) levels are reflected in the PIN.

1.2 PIN. The PIN is as shown in the following example:



1.2.1 RHA designator. Device classes Q and V RHA marked devices meet the MIL-PRF-38535 specified RHA levels and are marked with the appropriate RHA designator. Device class M RHA marked devices meet the MIL-PRF-38535, appendix A specified RHA levels and are marked with the appropriate RHA designator. A dash (-) indicates a non-RHA device.

1.2.2 Device type(s). The device type(s) identify the circuit function as follows:

Device type	Generic number	Circuit function
01	AD9617S	Low distortion, precision, wide bandwidth operational amplifier
02	AD9617T	Low distortion, precision, wide bandwidth operational amplifier
03	AD9618S	Low distortion, precision, wide bandwidth operational amplifier
04	AD9618T	Low distortion, precision, wide bandwidth operational amplifier

1.2.3 Device class designator. The device class designator is a single letter identifying the product assurance level as follows:

Device class	Device requirements documentation
M	Vendor self-certification to the requirements for MIL-STD-883 compliant, non-JAN class level B microcircuits in accordance with MIL-PRF-38535, appendix A
Q or V	Certification and qualification to MIL-PRF-38535

1.2.4 Case outline(s). The case outline(s) are as designated in MIL-STD-1835 and as follows:

Outline letter	Descriptive designator	Terminals	Package style
P	GDIP1-T8 or CDIP2-T8	8	Dual-in-line
X	See figure 1	8	Dual small outline with gullwing leads

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1.2.5 Lead finish. The lead finish is as specified in MIL-PRF-38535 for device classes Q and V or MIL-PRF-38535, appendix A for device class M.

1.3 Absolute maximum ratings. 1/

Supply voltages ($\pm V_S$).....	± 7 V
Common mode input voltage	$\pm V_S$
Differential input voltage	3 V
Continuous output current 2/	70 mA
Power dissipation (P_D)	600 mW
Junction temperature (T_J)	+175°C
Storage temperature range	-65°C to +150°C
Lead temperature (soldering 10 seconds)	+300°C
Thermal resistance, junction-to-case (θ_{JC}):	
Case P	See MIL-STD-1835
Case X	20°C/W
Thermal resistance, junction-to-ambient (θ_{JA})	110°C/W

1.4 Recommended operating conditions.

Supply voltage ($\pm V_S$)	± 5 V
Operating temperature range (T_A)	-55°C to +125°C

2. APPLICABLE DOCUMENTS

2.1 Government specification, standards, and handbooks. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those listed in the issue of the Department of Defense Index of Specifications and Standards (DoDISS) and supplement thereto, cited in the solicitation.

SPECIFICATION

DEPARTMENT OF DEFENSE

MIL-PRF-38535 - Integrated Circuits, Manufacturing, General Specification for.

STANDARDS

DEPARTMENT OF DEFENSE

MIL-STD-883 - Test Method Standard Microcircuits.
MIL-STD-973 - Configuration Management.
MIL-STD-1835 - Interface Standard For Microcircuit Case Outlines.

- 1/ Stresses above the absolute maximum rating may cause permanent damage to the device. Extended operation at the maximum levels may degrade performance and affect reliability.
2/ Output is short circuit protected to ground, but not to supplies. Continuous short circuit to ground may effect device reliability.

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HANDBOOKS

DEPARTMENT OF DEFENSE

MIL-HDBK-103 - List of Standard Microcircuit Drawings (SMD's).
MIL-HDBK-780 - Standard Microcircuit Drawings.

(Unless otherwise indicated, copies of the specification, standards, and handbooks are available from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

3.1 Item requirements. The individual item requirements for device classes Q and V shall be in accordance with MIL-PRF-38535 and as specified herein or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein. The individual item requirements for device class M shall be in accordance with MIL-PRF-38535, appendix A for non-JAN class level B devices and as specified herein.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535 and herein for device classes Q and V or MIL-PRF-38535, appendix A and herein for device class M.

3.2.1 Case outline(s). The case outline(s) shall be in accordance with 1.2.4 herein.

3.2.2 Terminal connections. The terminal connections shall be as specified on figure 1.

3.3 Electrical performance characteristics and postirradiation parameter limits. Unless otherwise specified herein, the electrical performance characteristics and postirradiation parameter limits are as specified in table I and shall apply over the full ambient operating temperature range.

3.4 Electrical test requirements. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are defined in table I.

3.5 Marking. The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked as listed in MIL-HDBK-103. For packages where marking of the entire SMD PIN number is not feasible due to space limitations, the manufacturer has the option of not marking the "5962-" on the device. For RHA product using this option, the RHA designator shall still be marked. Marking for device classes Q and V shall be in accordance with MIL-PRF-38535. Marking for device class M shall be in accordance with MIL-PRF-38535, appendix A.

3.5.1 Certification/compliance mark. The certification mark for device classes Q and V shall be a "QML" or "Q" as required in MIL-PRF-38535. The compliance mark for device class M shall be a "C" as required in MIL-PRF-38535, appendix A.

3.6 Certificate of compliance. For device classes Q and V, a certificate of compliance shall be required from a QML-38535 listed manufacturer in order to supply to the requirements of this drawing (see 6.6.1 herein). For device class M, a certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-HDBK-103 (see 6.6.2 herein). The certificate of compliance submitted to DSCC-VA prior to listing as an approved source of supply for this drawing shall affirm that the manufacturer's product meets, for device classes Q and V, the requirements of MIL-PRF-38535 and herein or for device class M, the requirements of MIL-PRF-38535, appendix A and herein.

3.7 Certificate of conformance. A certificate of conformance as required for device classes Q and V in MIL-PRF-38535 or for device class M in MIL-PRF-38535, appendix A shall be provided with each lot of microcircuits delivered to this drawing.

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TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions <u>1/</u> -55°C ≤ T _A ≤ +125°C unless otherwise specified	Group A subgroups	Device type	Limits <u>2/</u>		Unit
					Min	Max	
Input offset voltage	V _{IO}	T _A = +25°C <u>3/</u>	1	01,03	-1.1	+2.2	mV
				02,04	-0.0	+1.1	
Input offset voltage coefficient	TC _{VIO}	<u>4/</u>	1,2,3	All	-4	+25	μV/°C
Input bias current	-I _{IB}	Inverting, T _A = +25°C	1	01	-50	+50	μA
				02	-25	+25	
				03	-45	+45	
				04	-30	+30	
	+I _{IB}	Noninverting, T _A = +25°C		01	-25	+35	
				02	-15	+20	
				03	-25	+35	
				04	-13	+18	
Input bias current coefficient	TC _{IB}	Inverting <u>4/</u>	1,2,3	01,02	-50	+150	nA/°C
		Noninverting <u>4/</u>		03,04	-50	+130	
				All	-50	+125	
Common mode input voltage range	+V _{CM}		1,3	01,02	1.7		V
				03,04	1.4		
			2	01,02	1.4		
				03,04	1.0		
	-V _{CM}		1,3	01,02		-1.7	
				03,04		-1.4	
			2	01,02		-1.4	
				03,04		-1.0	
Common mode rejection ratio	CMRR	V _{CM} = ±0.25 V	4	All	48		dB
		5	44				
		6	50				
Power supply rejection ratio	PSRR	ΔV _S = ±5 %	4,5,6	All	50		dB
Output voltage swing	+V _{OUT}		1,2,3	01,02	3.4		V
	03,04			3.3			
	-V _{OUT}			01,02		-3.4	
				03,04		-3.3	
Output current	I _{OUT}	R _L = 50 Ω	1,2	All	60		mA
			3		50		

See footnotes at end of table.

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TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions <u>1/</u> -55°C ≤ T _A ≤ +125°C unless otherwise specified	Group A subgroups	Device type	Limits <u>2/</u>		Unit
					Min	Max	
Power supply quiescent current	+I _Q		1,2,3	01,02		48	mA
	-I _Q			03,04		43	
				01,02		48	
				03,04		43	
Small signal bandwidth (-3 dB)	SSBW	V _{OUT} ≤ 2 V _{PP}	4,5,6	01,02	145		MHz
				03,04	130		
Large signal bandwidth (-3 dB)	LSBW	V _{OUT} = 4 V _{PP} <u>4/</u>	4,5,6	01,02	115		MHz
		V _{OUT} ≤ 5 V _{PP} <u>4/</u>		03,04	120		
Amplitude of peaking	GFPL	< 50 MHz	4,6	01,02		0.3	dB
				03,04		0.4	
			5	01,02		0.6	
				03,04		0.7	
Amplitude of peaking	GFPH	> 50 MHz	4,6	01,02		0.8	dB
				03,04		0.6	
			5	01,02		1.0	
				03,04		1.2	
Amplitude of rolloff	GFR	< 75 MHz	4,5,6	01,02		0.6	dB
				03,04		1.2	
2nd harmonic distortion	HD2	2 V _{PP} , 4.3 MHz <u>4/</u>	4,5,6	01,02		-78	dBc
		2 V _{PP} , 20 MHz <u>4/</u>		03,04		-75	
				01,02		-59	
				03,04		-55	
		2 V _{PP} , 60 MHz		All		-43	
3rd harmonic distortion	HD3	2 V _{PP} , 4.3 MHz <u>4/</u>	4,5,6	01,02		-75	dBc
		2 V _{PP} , 20 MHz <u>4/</u>		03,04		-77	
				01,02		-61	
				03,04		-62	
				2 V _{PP} , 60 MHz	01,02		
		03,04			-54		
Slew rate	SR	V _{OUT} = 4 V step, <u>4/</u> measured at -2 V to +2 V	9,10,11	01,02	1100		V/μs
				03,04	1400		

See footnotes at end of table.

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TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions ^{1/} -55°C ≤ T _A ≤ +125°C unless otherwise specified	Group A subgroups	Device type	Limits ^{2/}		Unit
					Min	Max	
Rise and fall time	t _r , t _f	V _{OUT} = 2 V step ^{4/}	9,10,11	01,02		2.5	ns
				03,04		2.6	
		V _{OUT} = 4 V step ^{4/}	9,10 11	01,02		3.3	
						3.5	
		V _{OUT} = 5 V step ^{4/}	9,10 11	03,04		2.8	
						3.1	
Overshoot	OS	V _{OUT} = 2 V step ^{4/}	9,10,11	01,02		14	%
				03,04		10	
Settling time to 0.1 %	t _{s1}	V _{OUT} = 2 V step ^{4/}	9,10,11	All		15	ns
		V _{OUT} = 4 V step ^{4/}				16	
Settling time to 0.02 %	t _{s2}	V _{OUT} = 2 V step ^{4/}	9,10,11	All		23	ns
		V _{OUT} = 4 V step ^{4/}				24	

^{1/} For device types 01 and 02, unless otherwise specified, A_v = +3 V, ±V_S = ±5 V, feedback resistance (R_F) = 400 Ω, and load resistance (R_L) = 100 Ω. For device types 03 and 04, unless otherwise specified, A_v = +10, ±V_S = ±5 V, feedback resistance (R_F) = 1000 Ω, and load resistance R_L = 100 Ω.

^{2/} The algebraic convention, whereby the most negative value is a minimum and the most positive is a maximum, is used in this table. Negative current shall be defined as conventional current flow out of a device terminal.

^{3/} Measured with respect to the inverting input.

^{4/} If not tested, shall be guaranteed to the limits specified in table I herein.

3.8 Notification of change for device class M. For device class M, notification to DSCC-VA of change of product (see 6.2 herein) involving devices acquired to this drawing is required for any change as defined in MIL-STD-973.

3.9 Verification and review for device class M. For device class M, DSCC, DSCC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

3.10 Microcircuit group assignment for device class M. Device class M devices covered by this drawing shall be in microcircuit group number 49 (see MIL-PRF-38535, appendix A).

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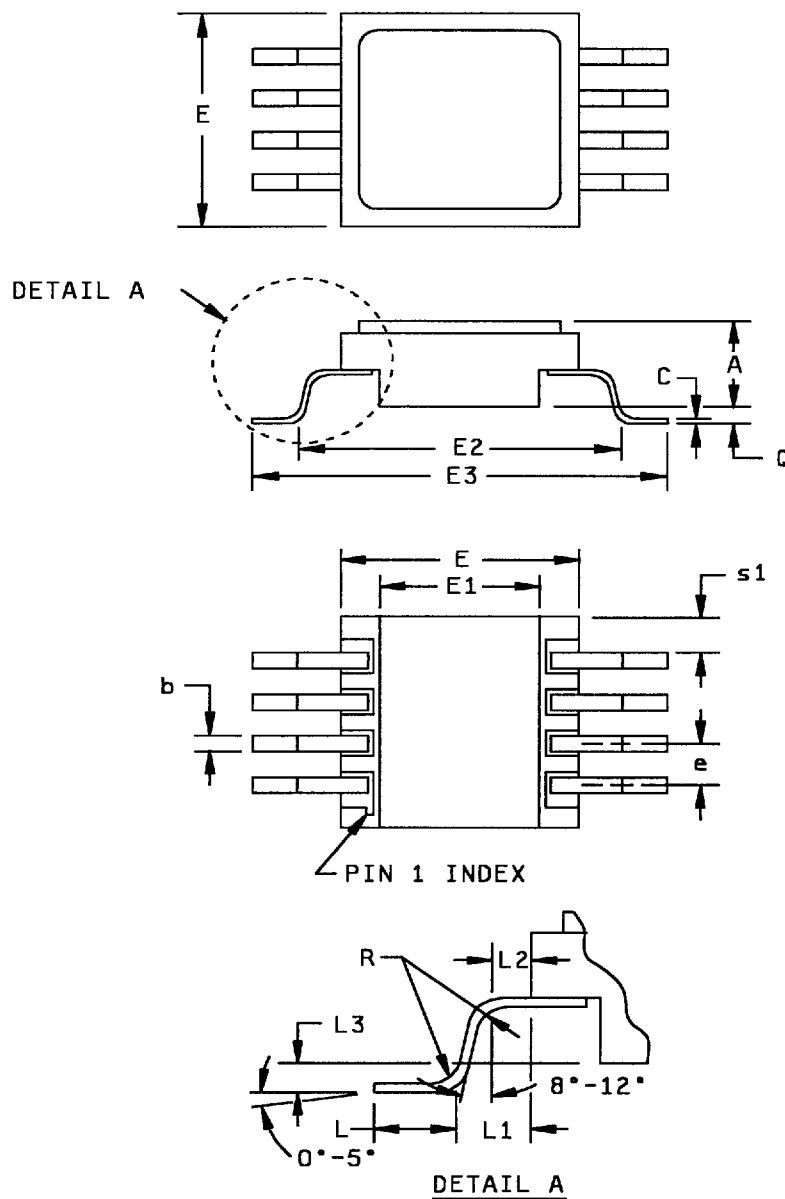


FIGURE 1. Case outline X.

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Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	2.11	2.62	.083	.103
b	.38	.48	.015	.019
c	0.13 BSC		.005 BSC	
E	6.35	6.60	.250	.260
E1	4.44	---	.175	---
E2	8.20	8.81	.323	.347
E3	11.00	11.61	.433	.457
e	1.27 BSC		.050 BSC	
L	1.02	---	.040	---
L1	1.52 BSC		.06 BSC	
L2	.64	---	.025	---
L3	.38	---	.015	---
R	.38	---	.015	---
S1	1.12	---	.044	---
S2	1.35	---	.053	---
Q	.38	---	.015	---
N	8		8	

NOTES:

1. The U.S. Government preferred system of measurement is the metric S.I. system. However, since this item was originally designed using inch-pound units of measurement, in the event of conflict between the metric and inch-pound units, the inch-pound shall take precedence.
2. Pin 1 is identified by a tab on the braze pad on the underside of the package.
3. Lead finish shall be hot solder dipped, or gold plated with nickel underplate. The lead material is alloy 42.
4. The lid is gold plated novar with nickel underplate.

FIGURE 1. Case outline X - Continued.

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Device type	01
Case outlines	P and X
Terminal number	Terminal symbol
1	NC (See note 1)
2	-INPUT
3	+INPUT
4	-V _s
5	-V _s (See note 2)
6	OUTPUT
7	+V _s
8	+V _s (See note 3)

NOTES:

1. NC = No connection
2. Optional -V_s pin
3. Optional +V_s pin

FIGURE 2. Terminal connections.

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4. QUALITY ASSURANCE PROVISIONS

4.1 Sampling and inspection. For device classes Q and V, sampling and inspection procedures shall be in accordance with MIL-PRF-38535 or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein. For device class M, sampling and inspection procedures shall be in accordance with MIL-PRF-38535, appendix A.

4.2 Screening. For device classes Q and V, screening shall be in accordance with MIL-PRF-38535, and shall be conducted on all devices prior to qualification and technology conformance inspection. For device class M, screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection.

4.2.1 Additional criteria for device class M.

a. Burn-in test, method 1015 of MIL-STD-883.

(1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015.

(2) $T_A = +125^{\circ}\text{C}$, minimum.

b. Interim and final electrical test parameters shall be as specified in table II herein.

4.2.2 Additional criteria for device classes Q and V.

a. The burn-in test duration, test condition and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The burn-in test circuit shall be maintained under document revision level control of the device manufacturer's Technology Review Board (TRB) in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015 of MIL-STD-883.

b. Interim and final electrical test parameters shall be as specified in table II herein.

c. Additional screening for device class V beyond the requirements of device class Q shall be as specified in MIL-PRF-38535, appendix B.

4.3 Qualification inspection for device classes Q and V. Qualification inspection for device classes Q and V shall be in accordance with MIL-PRF-38535. Inspections to be performed shall be those specified in MIL-PRF-38535 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.4).

4.4 Conformance inspection. Technology conformance inspection for classes Q and V shall be in accordance with MIL-PRF-38535 including groups A, B, C, D, and E inspections and as specified herein except where option 2 of MIL-PRF-38535 permits alternate in-line control testing. Quality conformance inspection for device class M shall be in accordance with MIL-PRF-38535, appendix A and as specified herein. Inspections to be performed for device class M shall be those specified in method 5005 of MIL-STD-883 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.4).

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TABLE II. Electrical test requirements.

Test requirements	Subgroups (in accordance with MIL-STD-883, method 5005, table I)	Subgroups (in accordance with MIL-PRF-38535, table III)	
	Device class M	Device class Q	Device class V
Interim electrical parameters (see 4.2)	1	1	1
Final electrical parameters (see 4.2)	1,2,3 1/	1,2,3 1/	1,2,3 1/
Group A test requirements (see 4.4)	1,2,3,4,5,6, 2/ 9,10,11	1,2,3,4,5,6 2/ 9,10,11	1,2,3,4,5,6, 2/ 9,10,11
Group C end-point electrical parameters (see 4.4)	1	1	1
Group D end-point electrical parameters (see 4.4)	1	1	1
Group E end-point electrical parameters (see 4.4)	---	---	---

1/ PDA applies to subgroup 1.

2/ Subgroups 9, 10, and 11 are guaranteed, if not tested, to the limits specified in table I herein.

4.4.1 Group A inspection.

- Tests shall be as specified in table II herein.
- Subgroups 7 and 8 in table I, method 5005 MIL-STD-883 shall be omitted.

4.4.2 Group C inspection. The group C inspection end-point electrical parameters shall be as specified in table II herein.

4.4.2.1 Additional criteria for device class M. Steady-state life test conditions, method 1005 of MIL-STD-883:

- Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005 of MIL-STD-883.
- $T_A = +125^\circ\text{C}$, minimum.
- Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

4.4.2.2 Additional criteria for device classes Q and V. The steady-state life test duration, test condition and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The test circuit shall be maintained under document revision level control by the device manufacturer's TRB in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005 of MIL-STD-883.

4.4.3 Group D inspection. The group D inspection end-point electrical parameters shall be as specified in table II herein.

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4.4.4 Group E inspection. Group E inspection is required only for parts intended to be marked as radiation hardness assured (see 3.5 herein).

- a. End-point electrical parameters shall be as specified in table II herein.
- b. For device classes Q and V, the devices or test vehicle shall be subjected to radiation hardness assured tests as specified in MIL-PRF-38535 for the RHA level being tested. For device class M, the devices shall be subjected to radiation hardness assured tests as specified in MIL-PRF-38535, appendix A for the RHA level being tested. All device classes must meet the postirradiation end-point electrical parameter limits as defined in table I at $T_A = +25^{\circ}\text{C} \pm 5^{\circ}\text{C}$, after exposure, to the subgroups specified in table II herein.
- c. When specified in the purchase order or contract, a copy of the RHA delta limits shall be supplied.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-PRF-38535 for device classes Q and V or MIL-PRF-38535, appendix A for device class M.

6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.

6.1.1 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor prepared specification or drawing.

6.1.2 Substitutability. Device class Q devices will replace device class M devices.

6.2 Configuration control of SMD's. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished in accordance with MIL-STD-973 using DD Form 1692, Engineering Change Proposal.

6.3 Record of users. Military and industrial users should inform Defense Supply Center Columbus when a system application requires configuration control and which SMD's are applicable to that system. DSCC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronic devices (FSC 5962) should contact DSCC-VA, telephone (614) 692-0525.

6.4 Comments. Comments on this drawing should be directed to DSCC-VA, Columbus, Ohio 43216-5000, or telephone (614) 692-0674.

6.5 Abbreviations, symbols, and definitions. The abbreviations, symbols, and definitions used herein are defined in MIL-PRF-38535 and MIL-HDBK-1331.

6.6 Sources of supply.

6.6.1 Sources of supply for device classes Q and V. Sources of supply for device classes Q and V are listed in QML-38535. The vendors listed in QML-38535 have submitted a certificate of compliance (see 3.6 herein) to DSCC-VA and have agreed to this drawing.

6.6.2 Approved sources of supply for device class M. Approved sources of supply for class M are listed in MIL-HDBK-103. The vendors listed in MIL-HDBK-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DSCC-VA.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-90868
		REVISION LEVEL B	SHEET 13

DSCC FORM 2234
APR 97

9004708 0037722 684

STANDARD MICROCIRCUIT DRAWING BULLETIN

DATE: 98-07-22

Approved sources of supply for SMD 5962-90868 are listed below for immediate acquisition information only and shall be added to MIL-HDBK-103 and QML-38535 during the next revision. MIL-HDBK-103 and QML-38535 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DSCC-VA. This bulletin is superseded by the next dated revision of MIL-HDBK-103 and QML-38535.

Standard microcircuit drawing PIN <u>1</u> /	Vendor CAGE number	Vendor similar PIN <u>2</u> /
5962-9086801MPA	24355	AD9617SQ/883B
5962-9086801MXA	24355	AD9617SZ/883B
5962-9086802MPA	24355	AD9617TQ/883B
5962-9086802MXA	24355	AD9617TZ/883B
5962-9086803MPA	24355	AD9618SQ/883B
5962-9086803MXA	24355	AD9618SZ/883B
5962-9086804MPA	24355	AD9618TQ/883B
5962-9086804MXA	24355	AD9618TZ/883B

- 1/ The lead finish shown for each PIN representing a hermetic package is the most readily available from the manufacturer listed for that part. If the desired lead finish is not listed, contact the vendor to determine its availability.
- 2/ Caution. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

Vendor CAGE
number

24355

Vendor name
and address

Analog Devices
RT 1 Industrial Park
P.O. Box 9106
Norwood, MA 02062
Point of contact: 7910 Traid Center Drive
Greensboro, NC 95050-8020

The information contained herein is disseminated for convenience only and the Government assumes no liability whatsoever for any inaccuracies in the information bulletin.